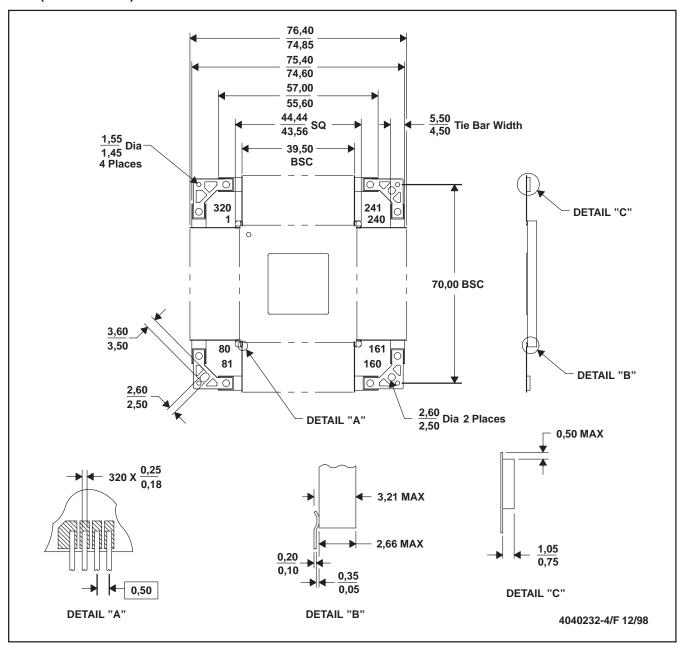
HFH (R-CQFP-F320)

CERAMIC QUAD FLATPACK WITH NCTB



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a metal lid.
- D. The terminals are gold-plated.
- E. Leads not shown for clarity purposes
- F. Falls within JEDEC MO-134AD



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